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**Lecture No - 34** 

## **Earlier Lecture**

- Cryogenic vessels use insulation to minimize all modes of heat transfer.
- Apparent thermal conductivity ( $k_A$ ) is calculated based on all possible modes of heat transfer.
- Expanded foam is a low density, cellular structure. A gas filled powder or a fibrous insulation reduces the gas convection due to the small size of voids.
- Radiation heat transfer is reduced by using radiation shields.

## **Outline of the Lecture**

#### **Topic : Cryogenic Insulation (contd)**

- Vacuum
- Evacuated Powders
- Opacified Powders
- Tutorial

## **Types of Insulation**

- Expanded Foam Mass
- Gas Filled Powders & Fibrous Materials Mass
- Vacuum alone Vacuum
- Evacuated Powders Mass + Vacuum
- Opacified Powders Mass + Vacuum + Reflective
- Multilayer Insulation Vacuum + Reflective

## **Introduction**

- As seen earlier, the different modes of heat transfer are Conduction, Convection and Radiation.
- If the physical matter between the hot and the cold surfaces is removed, that is, by maintaining a perfect vacuum, Conduction and Convection are eliminated.
- However, Radiation heat transfer does not require any medium and in such cases, it is the only mode of heat transfer.

- It is important to note that even in vacuum, there is some residual gas.
- These gas molecules contribute to the heat transfer by gaseous conduction.
- As the vacuum improves, this gas conduction decreases.
- In an ordinary conduction, a linear temperature gradient is built up. The molecules exchange heat with each other and as well as with the surfaces.

## **Vacuum**

- But in vacuum, the mean free path (**λ**) of the molecules is more than the distance between the surfaces; the molecules rarely collide with each other.
- The energy is exchanged only between the surface and the colliding molecules.
- This type of heat transfer is called as free molecular conduction or residual gas conduction.
- This exists only at very low pressures or at very good vacuum.



- For the sake of understanding, consider two plates with temperatures  $T_1$  and  $T_2$ ,  $(T_2 >$  $T_1$ ) as shown.
- The gas pressure is very low in order to ensure that the mean free path (**λ**) of the molecules is greater than **L**.
- In such situations, the gas molecules collide only with the surfaces and exchange energy.

## **Vacuum**



- Consider a molecule colliding with bottom plate and leaving towards upper plate.
- The gas molecule collides with this surface at  $T_1$  and it transfers some energy to the surface.
- It leaves the cold surface with a kinetic energy corresponding to a temperature **T' <sup>1</sup>**, higher than  $T_1$ .



- Again, consider a molecule colliding with upper plate and leaving towards bottom plate.
- This gas molecule collides with surface at **T**<sub>2</sub> and leaves at a temperature  $T'_2$ , lower than  $T_2$ .
- It is clear that, in both these impacts, thermal equilibrium is not attained. This process is repeated and contributes to free molecular conduction.

- In order to measure the degree of thermal equilibrium between the molecule and the surface, we define Accommodation Coefficient (**a**).
- It is a ratio of actual energy transfer to the maximum possible energy transfer.
- Mathematically, *Actual Heat Transfer <sup>a</sup> Max Heat Transfer*  $a = -$
- Its value depends on the gas surface interaction and the temperature of the surface.



- From the figure, for the cold surface, the actual temperature change is  $(T'_2 - T'_1)$ .
- But, the maximum possible temperature change is  $(T'_2 - T_1)$ .
- By definition, the accommodation coefficient for cold plate is



## **Vacuum**



- Similarly, for the hot surface, the actual temperature change is  $(T'_2 - T'_1)$ .
- But, the maximum possible temperature change is  $(T_2 - T'_1)$ .
- Therefore, the accommodation coefficient for the hot surface is

given by

$$
a_2 = \frac{T_2^{'} - T_1^{'} }{T_2 - T_1^{'} }
$$

## **Vacuum**

• From the earlier slides, the accommodation coefficients are

$$
a_1 = \frac{T_2^{\prime} - T_1^{\prime}}{T_2^{\prime} - T_1} \qquad a_2 = \frac{T_2^{\prime} - T_1^{\prime}}{T_2 - T_1^{\prime}}
$$

Rearranging the above equations, we have

$$
T_1 = T_2 \frac{T_2' - T_1'}{a_1} \qquad T_2 = \frac{T_2' - T_1}{a_2} + T_1'
$$

$$
T_2 - T_1 = (T_2' - T_1') \left(\frac{1}{a_1} + \frac{1}{a_2} - 1\right)
$$

$$
T_2 - T_1 = (T_2 - T_1) \left( \frac{1}{a_1} + \frac{1}{a_2} - 1 \right)
$$

Similar to an emissivity factor, we define a term accommodation factor **F**<sub>a</sub>, which is given by

$$
\frac{1}{F_a} = \left(\frac{1}{a_1} + \frac{1}{a_2} - 1\right)
$$

$$
T_2 - T_1 = (T_2 - T_1) \frac{1}{F_a} \qquad F_a = \frac{T_2 - T_1}{T_2 - T_1}
$$

## **Vacuum**

The approximate accommodation coefficients for concentric sphere and concentric cylinder geometries are as tabulated below.



• The subscript **1** denotes the enclosed surface and subscript **2** denotes the enclosure.



- At a given temperature, the accommodation coefficient increases with the increase in the molecular weight of the gas.
- For a given gas, the accommodation coefficient increases with the decrease in the temperature, due to better heat transfer at lower temperatures.

## **Vacuum**

- From the kinetic theory of gases, the total energy of a molecule is the sum of internal energy and kinetic energy.
- Mathematically,

$$
e=U+KE
$$

$$
e = \left(c_v + \frac{R}{2}\right)T
$$

 $\Delta e = \left(c_v + \frac{R}{2}\right)\Delta T$ 

• where,

- R Specific gas constant
- $c_v = R/(v-1)$  Specific heat of gas
- $\Delta T = (T'_2 T'_1)$  Change in temperature

$$
\text{Vacuum}
$$

$$
\Delta e = \left(c_v + \frac{R}{2}\right)\Delta T
$$

• The definition of  $C_v$  and  $F_a$  are as given below.

$$
c_v = \frac{R}{\gamma - 1} \quad T_2 - T_1 = F_a (T_2 - T_1)
$$

• Substituting, we have

$$
\Delta e = \left(\frac{R}{\gamma - 1} + \frac{R}{2}\right) \left(T_2 - T_1\right) F_a
$$

$$
\Delta e = \frac{F_a R}{2} (T_2 - T_1) \left( \frac{\gamma + 1}{\gamma - 1} \right)
$$

## **Vacuum**

• The mass flux per unit time is given by



- where,
	- $\rho$  Density,  $\bar{\upsilon}$  Average velocity
- From Kinetic theory, average velocity is



2

 $= p \left( \frac{1}{2 \pi RT} \right)$ 

 $\frac{m}{A} = p \left( \frac{1}{2 \pi R T} \right)$ 

• Combining the above, together with equation of state, we have  $1(-p)(8RT)^{0.5}$  $\dot{m}$  *p*  $\bigcap$  *8RT*  $\left( \begin{array}{c} p \end{array} \right) \left( \begin{array}{c} 8RT \end{array} \right)$  $\dot{n}$  1 (  $p$  ) (  $8RT$  )  $^{0.5}$  |  $\dot{m}$  (  $1$  ) $^{0.5}$ *m*  $\begin{pmatrix} 1 \end{pmatrix}$  $\dot{\gamma}$ 

 $A$  *A*  $(RT)$  *π* 

4

<sup>20</sup> **Prof. M D Atrey, Department of Mechanical Engineering, IIT Bombay**

 $=\frac{1}{4}\left(\frac{P}{RT}\right)\left(\frac{GRT}{\pi}\right)$ 

## **Vacuum**

• The total energy transfer per unit area owing to the molecular conduction is as given below.

$$
\frac{\dot{Q}}{A} = \frac{\dot{m}}{A} \Delta e \left[ \frac{\dot{m}}{A} \right] = p \left( \frac{1}{2\pi RT} \right)^{0.5} \left[ \Delta e \right] = \frac{F_a R}{2} (T_2 - T_1) \left( \frac{\gamma + 1}{\gamma - 1} \right)
$$
\n
$$
\frac{\dot{Q}}{A} = p \left( \frac{1}{2\pi RT} \right)^{0.5} \left( \frac{F_a R}{2} (T_2 - T_1) \left( \frac{\gamma + 1}{\gamma - 1} \right) \right)
$$
\n
$$
\frac{\dot{Q}}{A} = \left( \left( \frac{\gamma + 1}{\gamma - 1} \right) \left( \frac{R}{8\pi T} \right)^{0.5} F_a \right) p(T_2 - T_1)
$$

• **T** is the temperature of the pressure gauge measuring the gas pressure.

$$
\frac{\dot{Q}}{A} = \left( \left( \frac{\gamma + 1}{\gamma - 1} \right) \left( \frac{R}{8\pi T} \right)^{0.5} F_a \right) p(T_2 - T_1)
$$

In the above equation, let us denote the term in the parenthesis by **G**. We have,

$$
\dot{Q} = G \ p \ A \ (T_2 - T_1)
$$

• **Q** is valid only when the distance (**L**) between the plates is less than the mean free path (**λ**). Mathematically,

$$
L < \lambda = \frac{\mu}{p} \left( \frac{\pi RT}{2} \right)^{0.5}
$$

$$
\dot{Q} = GpA(T_2 - T_1) \qquad \lambda = \frac{\mu}{p} \left(\frac{\pi RT}{2}\right)^{0.5}
$$

- From the above two equations, it is clear that the
	- The free molecular regime can be achieved by achieving very good vacuum.
	- The free molecular conduction heat transfer can be made negligible compared to other modes, by lowering the pressure, decreasing F<sub>a</sub>, decreasing  $(T_2 - T_1)$ .

- Gas conduction is the primary and the dominant mode of heat transfer in a gas filled powder and fibrous insulations.
- One of the obvious ways to reduce this heat transfer is to evacuate the powder and the fibrous insulations.
- Usually, the vacuum that is commonly maintained in these insulations is in the range of **103** to **10-5** torr. **1** torr = 1 mm of Hg.



- The adjacent figure shows the variation of  $k_A$  with the residual gas pressure inside an evacuated powder insulation.
- $k_{A}$  is independent of residual gas pressures lying between atmospheric and 15 torr.



- With the lowering of pressure, 15 torr to 10-3 torr,  $k_A$  becomes directly proportional to the pressure.
- It varies almost linearly on a logarithmic chart as shown.
- Here, the modes of heat transfer are due to radiation, solid conduction and free molecular Residual gas pressure - torr conduction (dominant).



- With the further lowering of pressure, below **10-3** torr, the variation of  $k_A$  is almost null.
- The mode of heat transfer is primarily due to solid conduction and radiation.
- Evacuated powders are superior in performance than vacuum alone in **300**-**77 K**, as the radiation heat transfer Residual gas pressure - torr is comparatively less.



- At low pressures and temperatures, the solid conduction in evacuated powder dominates the radiant heat transfer.
- Hence, it is more advantageous to use vacuum alone in **77 K** to **4 K**. From Fourier's Law, we have

$$
\dot{Q} = \frac{k_A A_m (T_h - T_c)}{\Delta x}
$$

#### $\dot{Q} = \frac{k_A A_m (T_h - T_c)}{T_c}$ *x*  $=\frac{k_A A_m (T_h -$ ∆  $\dot{\tilde{\text{c}}}$ **Evacuated Powder**

- where,
	- $k_A$  = Apparent thermal conductivity
	- $T_h T_c$  = Temperature difference
	- $\Delta x =$  Distance
	- $A_m$  = Mean area of insulation.  $A_m$  for concentric cylinders and concentric spheres is as given below.

$$
A_{m,cyl} = \frac{A_2 - A_1}{\ln A_2}
$$

$$
A_{m, sph} = (A_1 A_2)^{\frac{1}{2}}
$$

## **Evacuated Powder**

- The apparent thermal conductivity and density of few commonly used evacuated powder insulations are as shown.
- The residual gas pressure is less than 10<sup>-3</sup> torr for temperatures between **77 K** to **300 K**.



- Radiation heat transfer still contributes to the heat in leak in **300 K** to **77 K** temperature range in case of evacuated powders.
- In the year 1960, **Riede** and **Wang**, **Hunter** *et. al*. minimized this radiant heat transfer by addition of reflective flakes made of **Al** or **Cu** to the evacuated powder.
- These flakes act like radiant shields in the tiny heat transfer paths that are formed in the interstices of the evacuated powder.



- The figure shows the variation of % opacifier with thermal conductivity for **Cu** – **santocel** and **Al** – **santocel**.
- There exists an optimum operating point for each of these insulations.
- It has been observed that, with these additions,  $k_A$  can be reduced by 5 times.



- **Cu** flakes are more preferred as compared to **Al** flakes.
- The **Al** flakes have large heat of combustion.
- These together with **O**<sub>2</sub> can lead to accidents when used on **LOX** containers.



- Another disadvantage of this insulation is that the vibrations tend to pack the flakes together.
- This, not only increases the thermal conductivity but also short circuits the conduction heat transfer.

## **Opacified Powder Insulation**

- The apparent thermal conductivity (mW/mK) and density (kg/m3) of few commonly used opacified powder insulations are as shown.
- The residual gas pressure is less than 10-3 torr for temperatures between **77 K** to **300 K**.



## **Tutorial**



• A spherical **LN2** vessel (**e**=0.8) is as shown. The inner and outer radii are 1.2m and 1.6m respectively. Compare and comment on the heat in leak for the following cases.

- Perlite (26 mW/mK)
- Less Vacuum (1.5mPa)
- Vacuum alone
- Vacuum + 10 shields  $(e_s = 0.05)$
- Evacuated Fine Perlite (0.95 mW/mK)
- 50/50 Cu Santocel (0.33 mW/mK)

## **Tutorial**

#### **Given**

Apparatus : Spherical vessel (**e**=0.8)

Working Fluid : Liquid Nitrogen

Temperature : 77 K (inner), 300 K (outer)

#### **Calculate heat in leak**

- **1** Perlite (26 mW/mK)
- **2** Less Vacuum (1.5mPa)
- **3** Vacuum alone
- **4** Vacuum + 10 shields
- **5** Evacuated Fine Perlite (0.95 mW/mK)
- **6** 50/50 Cu Santocel (0.33 mW/mK)
- The shape factor between the two containers is assumed to be 1.

## **Tutorial**



## **Tutorial**



• **Sphere** - R1=1.6m, R2=1.2m, e1=e2=0.8, T1=77 K, T2=300 K.

The net heat transfer is due to both radiation and residual gas conduction. **77 K**

$$
F_e = \left(\frac{1}{e_1} + \left(\frac{A_1}{A_2}\right)\left(\frac{1}{e_2} - 1\right)\right)^{-1}
$$

$$
F_e = \left(\frac{1}{0.8} + \left(\frac{1.2}{1.6}\right)^2 \left(\frac{1}{0.8} - 1\right)\right)^{-1} = 0.72
$$

## **Tutorial**



## **Tutorial**



• It is clear that the mean free path (**λ**) is greater than distance between the surfaces (0.4m).

## **Tutorial**



## **Tutorial**



## **Tutorial**



 $Q = 11.02W$ 

## **Tutorial**



50/50 Cu – Santocel ( $k_A = 0.33$ mW/m-K)

• **Sphere** -  $R_1 = 1.6$ m,  $R_2 = 1.2$ m,  $k_{A}$  $\Delta T = (300 - 77) = 223$ .

$$
Q = \frac{4\pi k_A R_1 R_2 \Delta T}{\left(R_2 - R_1\right)} \qquad Q = 4.41W
$$

## **Tutorial**



## **Summary**

- In vacuum, the radiation is the dominant mode of heat transfer.
- Evacuated powders are superior in performance than vacuum alone in **300**-**77 K**, as the radiation heat transfer is comparatively less.
- At low pressures and temperatures, the solid conduction in evacuated powder dominates the radiant heat transfer.
- <sup>47</sup> **Prof. M D Atrey, Department of Mechanical Engineering, IIT Bombay** In an opacified powder, the radiation heat transfer is minimized by addition of reflective flakes.

## **Thank You!**